

#### Is Now Part of



# ON Semiconductor®

# To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to Fairchild <a href="guestions@onsemi.com">guestions@onsemi.com</a>.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer

January 2016



FFB20UP30DN

# 20 A, 300 V, Ultrafast Dual Diode

#### **Features**

- Ultrafast Recovery,  $t_{rr}$  = 45 ns (@  $I_F$  = 10 A)
- Max Forward Voltage, V<sub>F</sub> = 1.3 V (@ T<sub>C</sub> = 25°C)
- Reverse Voltage: V<sub>RRM</sub> = 300 V
- · Avalanche Energy Rated
- · RoHS Compliant

## **Applications**

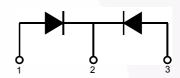
- General Purpose
- · SMPS,Welder
- · Free-Wheeling Diode for Motor Application
- · Power Switching Circuits

## **Description**

The FFB20UP30DN is an ultrafast dual diode with low forward voltage drop and rugged UIS capability. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial applicationa as welder application.



1.Anode 2.Cathode 3.Anode



1. Anode 2. Cathode 3. Anode

#### Absolute Maximum Ratings (per diode) T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Unit
$V_{RRM}$	Peak Repetitive Reverse Voltage	300	V
V <sub>RWM</sub>	Working Peak Reverse Voltage	300	V
V <sub>R</sub>	DC Blocking Voltage	300	V
I <sub>F(AV)</sub>	Average Rectified Forward Current (per Diode) @T <sub>C</sub> = 130°C	10	Α
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	180	А
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +175	°C

#### **Thermal Characteristics**

Symbol	Parameter	Ratings	Unit
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	2.0	°C/W

### **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFB20UP30DNTM	F20UP30DN	D <sup>2</sup> -PAK	Reel	13" Dia	N/A	800

# **Electrical Characteristics** (per diode) $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Min.	Тур.	Max.	Unit	
V <sub>F</sub> *	I <sub>F</sub> = 10 A I <sub>F</sub> = 10 A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 150 °C	-	-	1.3 1.2	V V
I <sub>R *</sub>	V <sub>R</sub> = 300 V V <sub>R</sub> = 300 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 150 °C	-	-	1 500	μ <b>Α</b> μ <b>Α</b>
T <sub>rr</sub>	$I_F$ =0.5 A, $I_{rr}$ =1 A, $V_{CC}$ = 30 V $I_F$ =1 A, $di_F/dt$ = 100 A/ $\mu$ s, $V_R$ = 30 V $I_F$ =10 A, $di_F/dt$ = 200 A/ $\mu$ s, $V_R$ = 195 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 25 °C T <sub>C</sub> = 25 °C	- - -	- - -	30 35 45	ns ns ns
t <sub>a</sub> t <sub>b</sub> Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di}_F/\text{dt} = 200 \text{ A/}\mu\text{s}, \text{ V}_R = 195\text{V}$	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 25 ^{\circ}\text{C}$	- - -	11 13 20	- - -	ns ns nC
W <sub>AVL</sub>	Avalanche Energy (L = 20 mH)	•	20	-	-	mJ

<sup>\*</sup>Pulse Test: Pulse Width=300  $\mu$ s, Duty Cycle=2%

#### **Test Circuit and Waveforms**

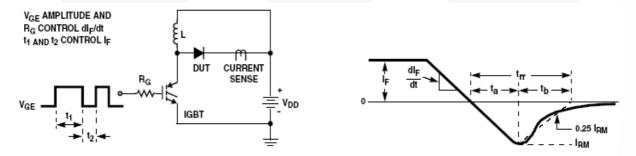


Figure 1. Diode Reverse Recovery Test Circuit & Waveform

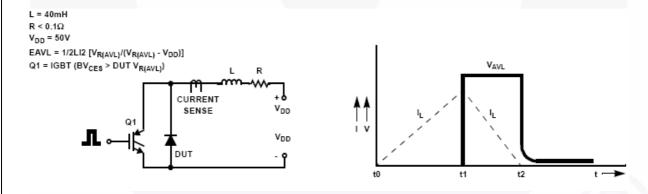


Figure 2. Unclamped Inductive Switching Test Circuit & Waveform

# **Typical Performance Characteristics**

Figure 3. Typical Forward Voltage Drop

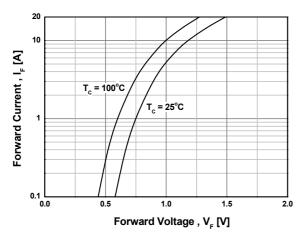


Figure 4. Typical Reverse Current

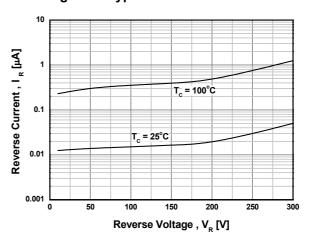


Figure 5. Typical Junction Capacitance

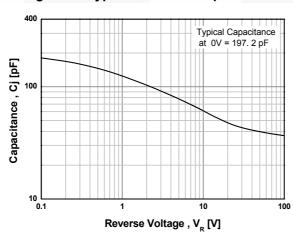


Figure 6. Typical Reverse Recovery Time

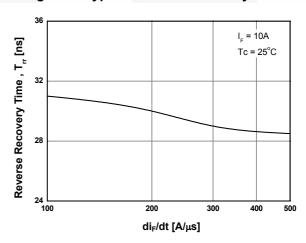
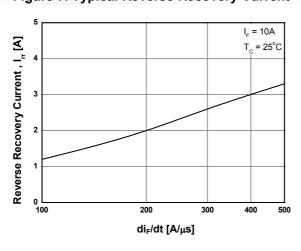
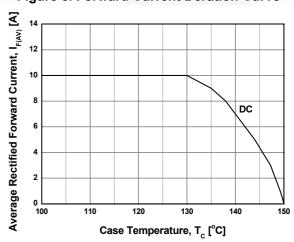
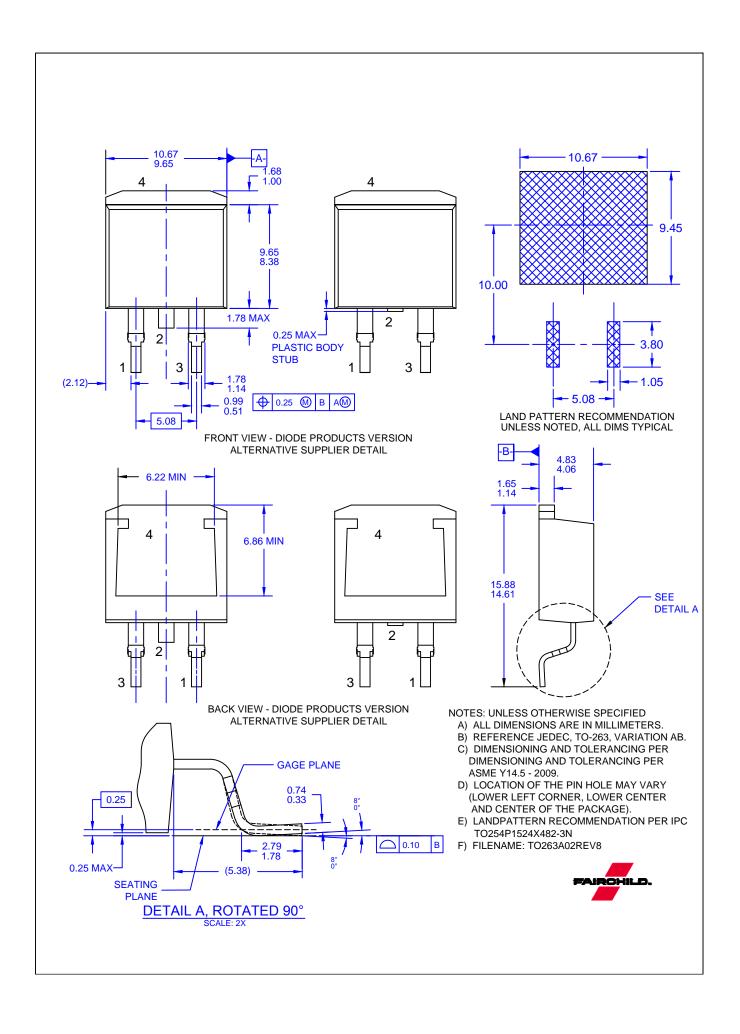


Figure 7. Typical Reverse Recovery Current



**Figure 8. Forward Current Deration Curve** 





ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdt/Patent-Marking.pdf">www.onsemi.com/site/pdt/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and exp

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative